

## NTP2955G-VB Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY		
V <sub>DS</sub>	-60	V
R <sub>DS(on)</sub> V <sub>GS</sub> = 10 V	62	mΩ
$R_{DS(on)}$ $V_{GS} = 4.5$ V	74	mΩ
I <sub>D</sub>	-40	А
Configuration	Sin	gle

#### FEATURES

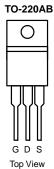
- Trench Power MOSFET
- 100 % UIS Tested

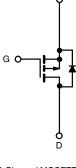
#### **APPLICATIONS**

Load Switch

S







P-Channe	MOSFET

Parameter		Symbol	Limit	Unit	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current ( $T_{I}$ = 175 °C)	T <sub>C</sub> = 25 °C	l-	-40		
Solution Solution (1) = 175 (S)	T <sub>C</sub> = 100 °C	I <sub>D</sub>	-30		
Pulsed Drain Current		I <sub>DM</sub>	- 90	А	
Continuing Source Current (Diode Conduction)		۱ <sub>S</sub>	- 30	1	
Avalanche Current		I <sub>AS</sub>	- 28		
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	7.2	mJ	
Maximum Dawar Dissinction	T <sub>C</sub> = 25 °C	D	60 <sup>a</sup>	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2 <sup>b</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
handling to Angleingth	$t \le 10 \text{ sec}$	D	20	25	
Junction-to-Ambient <sup>D</sup>	Steady State	R <sub>thJA</sub>	62	75	°C/W
Junction-to-Case		R <sub>thJC</sub>	5	6	

Notes:

a. See SOA curve for voltage derating.

b. Surface Mounted on 1" x 1" FR-4 boad.

<b>SPECIFICATIONS</b> $T_J = 25$	°C, unless	otherwise noted					
Parameter	Symbol	Test Conditions	Min	Тур <sup>а</sup>	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			v	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	- 1.0		- 3.0	v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ± 20 V			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = -60 V, V_{GS} = 0 V$			- 1		
	I <sub>DSS</sub>	$V_{DS}$ = - 60 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			- 50	μA	
		$V_{DS}$ = - 60 V, $V_{GS}$ = 0 V, $T_{J}$ = 175 °C			- 150		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 10 V	- 10			A	
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A		62		mΩ	
	r	$V_{GS}$ = - 10 V, $I_D$ = - 5 A, $T_J$ = 125 °C		80			
Drain-Source On-State Resistance <sup>b</sup>	r <sub>DS(on)</sub>	$V_{GS}$ = - 10 V, $I_D$ = - 5 A, $T_J$ = 175 °C		110			
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 2 A		74			
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 5 A		8		S	
Dynamic	•	•		•	•		
Input Capacitance	C <sub>iss</sub>			1300		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		120			
Reverse Transfer Capacitance	C <sub>rss</sub>			90			
Total Gate Charge	Qg			13		nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -8.4$ A		2.3			
Gate-Drain Charge	Q <sub>gd</sub>			3.2		1	
Gate Resistance	Rg	f = 1 MHz		8.0		Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			5	10		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = - 30 V, $R_L$ = 3.57 $\Omega$		14	25		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$\text{I}_{\text{D}}\cong$ - 8.4 A, $\text{V}_{\text{GEN}}$ = - 10 V, $\text{R}_{\text{G}}$ = 2.5 $\Omega$		15	25	ns	
Fall Time <sup>c</sup>	t <sub>f</sub>	]		7	12		
Source-Drain Diode Ratings and Cha	aracteristics	(T <sub>C</sub> = 25 °C) <sup>b</sup>			•	•	
Pulsed Current	I <sub>SM</sub>			- 20		А	
Forward Voltage <sup>b</sup>	V <sub>SD</sub>	I <sub>F</sub> = - 2 A, V <sub>GS</sub> = 0 V		- 0.9	- 1.3	V	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 8 A, di/dt = 100 A/μs		50	80	ns	
Reverse Recovery Time	Q <sub>rr</sub>	$r_{\rm F} = -6  {\rm A},  {\rm d} / {\rm d} t = 100  {\rm A} / {\rm \mu S}$		80	120	nC	
		·		•	•	•	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

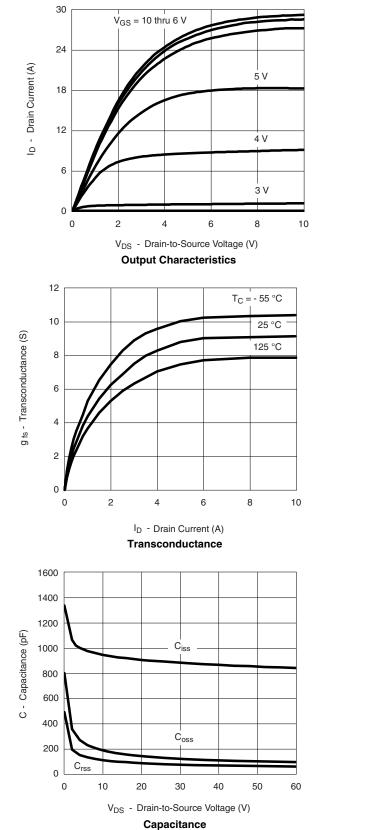
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

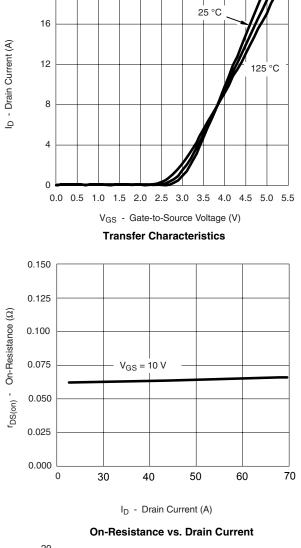
VBsemi Bsemi.com



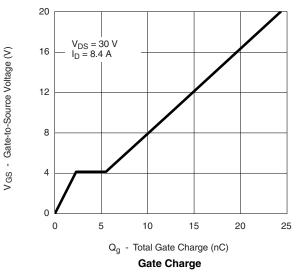
T<sub>C</sub> = - 55 °C



#### TYPICAL CHARACTERISTICS 25 °C unless noted

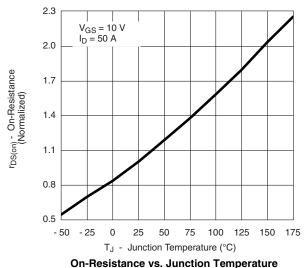


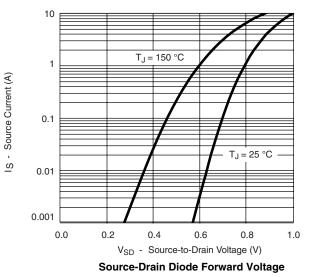
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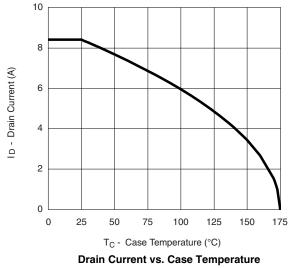


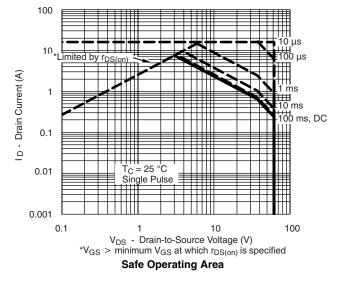
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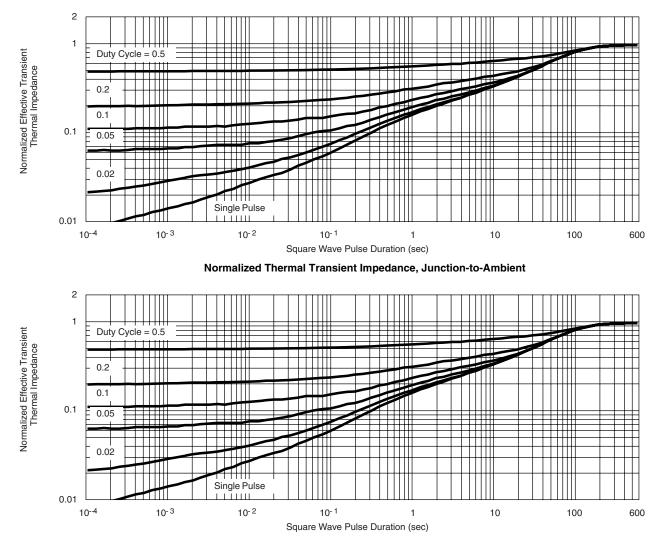
### THERMAL RATINGS





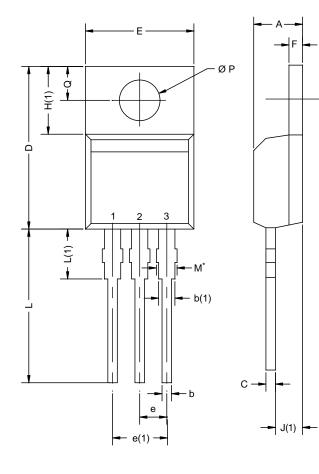


#### THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case





## **TO-220AB**

	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

#### Notes

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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